

WG30R135W1

Rev.01 - 23 March 2024

Product data sheet

1. General description

WG30R135W1 uses advanced Fine Trench Field-stop technology IGBT with monolithic body diode in TO-247 package. This device is part of Reverse-Conducting of IGBTs, which represents an optimum compromise between conduction and switching losses to maximize the efficiency for soft commutation.



2. Features and benefits

- Reverse Conducting IGBT with Monolithic Body Diode
- Maximum Junction Temperature 175 °C
- Low Conduction Losses
- Positive Temperature efficient for Easy Parallel Operating
- EMI Improved Design

3. Applications

- Microwave ovens
- Induction heating
- Resonant converters
- Soft switching applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter		Notes	s Value			Unit
V_{CE}	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$				1350		V
I _c	DC collector current, limited by $T_{j(max)}$ T _c = 100 °C				30		A
Symbol	Parameter Conditions		Notes	Min	Тур	Max	Unit
Static characteristics							
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V _{GE} = 15 V; I _C = 30 A; T _j = 25 °C		-	1.7	2.2	V

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		۹C
2	С	collector		
3	E	emitter		
mb	С	mounting base; connected to collector		G E sym200

6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
WG30R135W1	TO247	WG30R135W1Q	Tube	30	TO247P	09-Mar-2023	

7. Marking

Table 4. Marking codes					
Type number	Marking codes				
WG30R135W1	G30R135 W1				

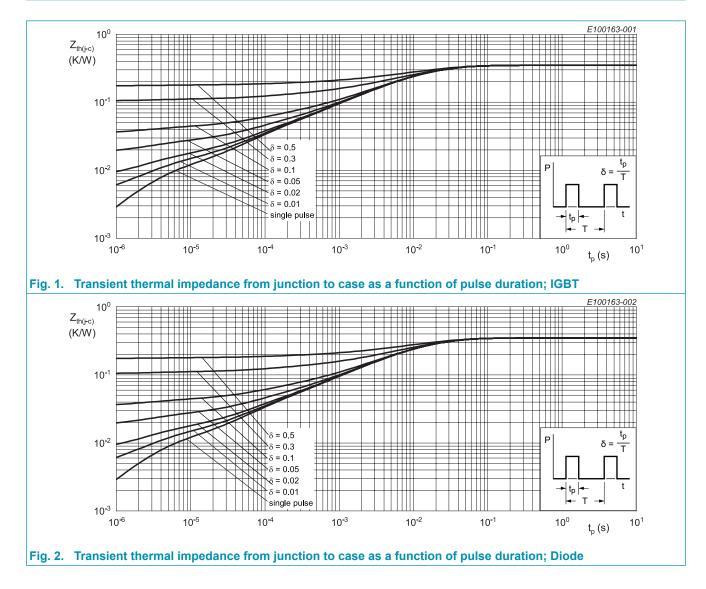
8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V _{CE}	Collector-emitter voltage, T _j ≥ 25 °C		1350	V
I _C	DC collector current, limited by $T_{j(max)}$ T _c = 25 °C T _c = 100 °C		60 30	A
I _{C(puls)}	Pulsed collector current, t_p limited by $T_{j(max)}$		90	А
I _{CSM}	Non repetitive peak collector current ⁽¹⁾		200	А
-	Turn off safe operating area V _{CE} \leq 1350 V, T _j \leq 175 °C, t _p = 1 µs		90	A
I _F	Diode forward current, limited by $T_{j(max)}$ T _c = 25 °C T _c = 100 °C		60 30	A
I _{Fpuls}	Diode pulsed current, t_p limited by $T_{j(max)}$		90	А
V_{GE}	Gate-emitter voltage		±25	V
P _{tot}	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		428 214	W
T _{stg}	Storage temperature		-55 to +150	°C
T _{jmax}	Maximum operating junction temperature		175	°C
-	Peak soldering temperture		260	°C
М	Mounting Torque with washer		0.55	Nm

 $^{\scriptscriptstyle (1)}$ capacitor charging saturation current limited by Tjmax < 175°C and tp < 3µs

9. Thermal characteristics

Table 6. Th	Fable 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
R _{th(j-c)}	IGBT thermal resistance from junction to case			-	0.35	-	K/W	
R _{th(j-c)}	Diode thermal resistance from junction to case			-	0.35	-	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient			-	40	-	K/W	



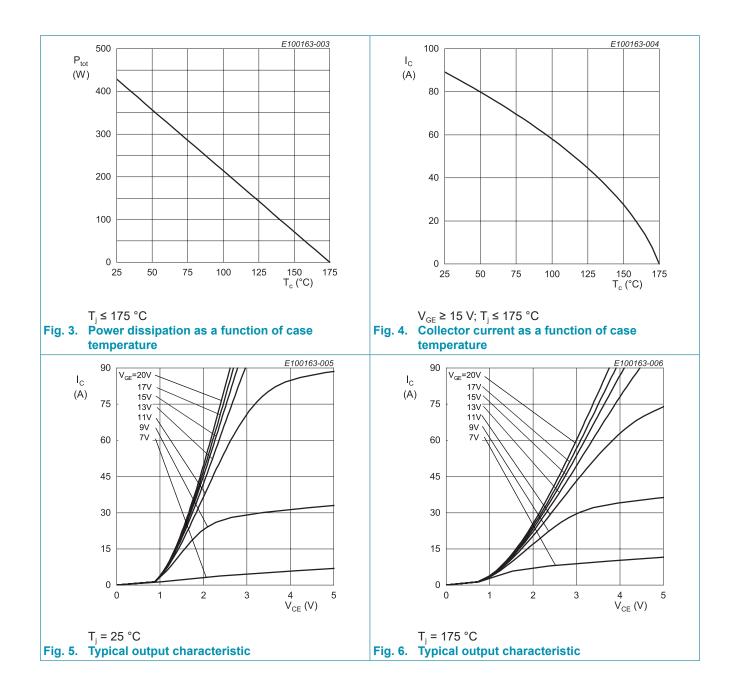
10. Characteristics

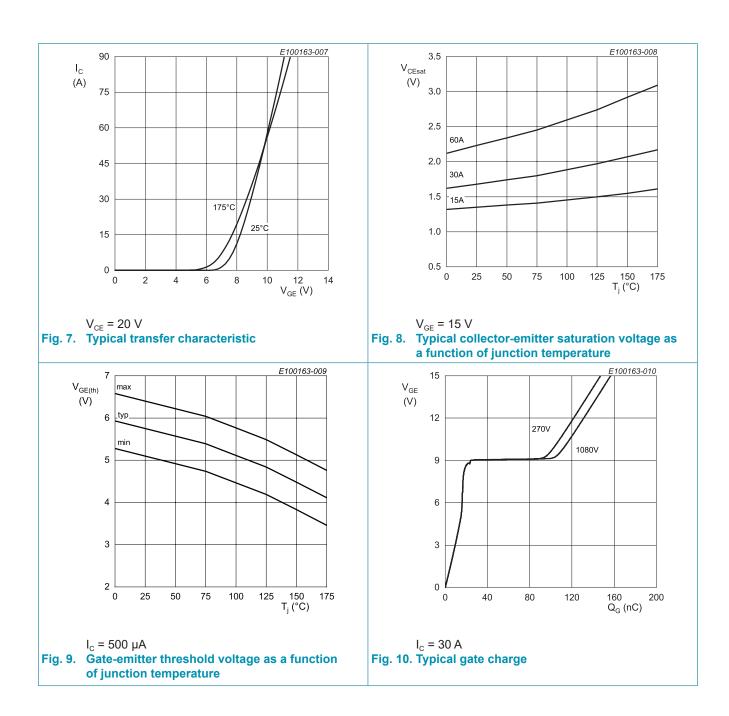
Table 7. Cl	naracteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
BV_{CES}	Collector-emitter breakdown voltage	$V_{GE} = 0 V; I_{C} = 1 mA$		1350	-	-	V
$V_{\text{CE(sat)}}$	Collector-emitter saturation	V _{GE} = 15 V; I _C = 30 A; T _j = 25 °C		-	1.7	2.2	V
	voltage	V _{GE} = 15 V; I _C = 30 A; T _j = 175 °C		-	2.2	-	V
V _F	Diode forward voltage	V _{GE} = 0 V; I _F = 30 A; T _j = 25 °C		-	1.9	2.3	V
		V _{GE} = 0 V; I _F = 30 A; T _j = 175 °C		-	2.3	-	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	I_{c} = 0.5 mA; V_{ce} = V_{ge}		5.1	5.75	6.4	V
I _{CES}	Zero gate voltage collector	V_{CE} = 1350 V; V_{GE} = 0 V; T_{j} = 25 °C		-	-	100	μA
	current	V _{CE} =1350 V;V _{GE} = 0 V; T _j = 175 °C		-	0.6	-	mA
I _{GES}	Gate-emitter leakage current	V _{CE} = 0 V; V _{GE} = 20 V		-	-	100	nA
g _{fs}	Transconductance	V _{CE} = 20 V; I _C = 30 A		-	24	-	S
Dynamic	characteristics						
C _{ies}	Input capacitance	V_{CE} = 30 V; V_{GE} = 0 V; f = 1 MHz;		-	3586	-	pF
C _{oes}	Output capacitance	T _j = 25 °C		-	56	-	pF
C _{res}	Reverse transfer capacitance			-	29	-	pF
Q _G	Gate charge	V _{CC} = 1080 V; I _C = 30 A; V _{GE} = 15 V; T _i = 25 °C		-	157	-	nC

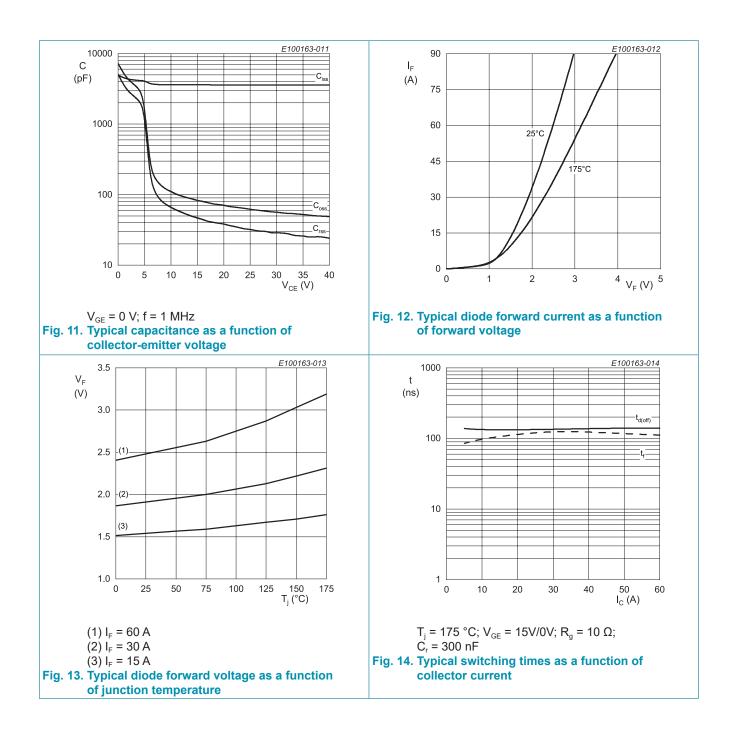
11. Switching Characteristics

Table 8. Switching Characteristics, Inductive Load								
Symbol	Parameter	Conditions	Notes	Min	Тур	Мах	Unit	
IGBT char	IGBT characteristics							
t _{d(off)}	Turn-off delay time			-	130	-	nS	
t _f	Fall time			-	106	-	nS	
E _{off}	Turn-off energy			-	129	-	uJ	
t _{d(off)}	Turn-off delay time	$T_j = 175 °C;$		-	134	-	nS	
t _f	Fall time	$I_{c} = 30 \text{ A}; V_{GE} = 15 \text{V} / 0 \text{V}; R_{G} = 10 \Omega;$ $C_{r} = 300 \text{ nF}; R = 2 \Omega$		-	132	-	nS	
E _{off}	Turn-off energy			-	280	-	uJ	

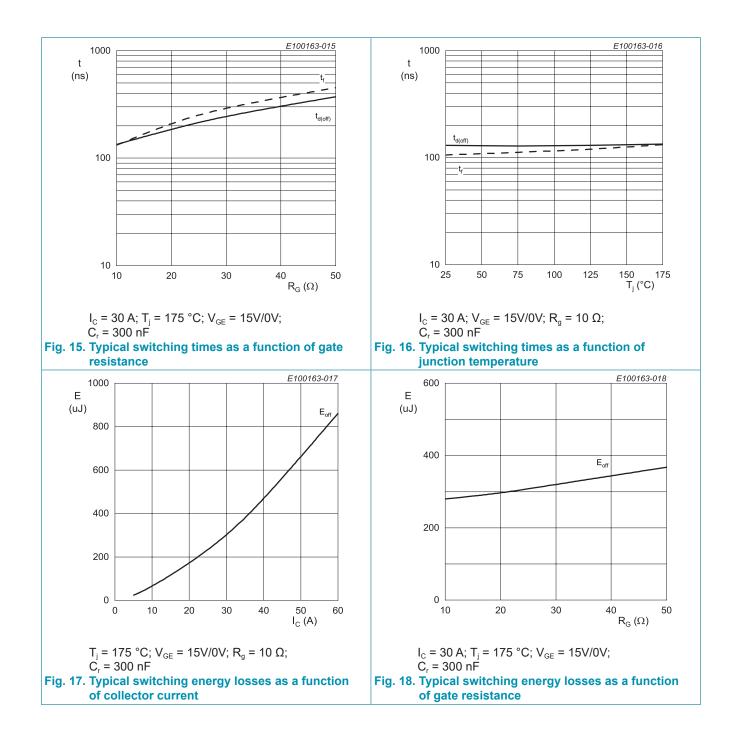
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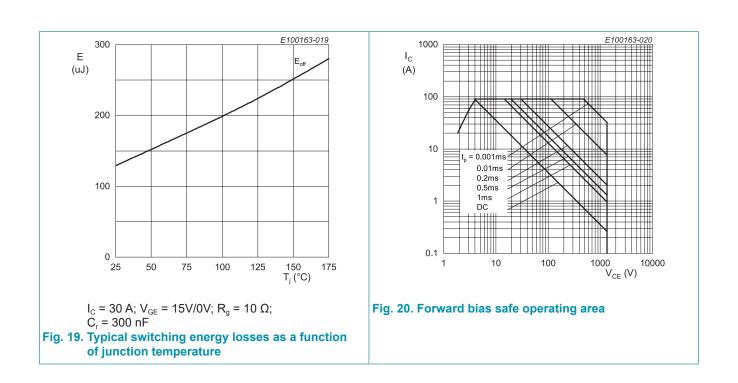






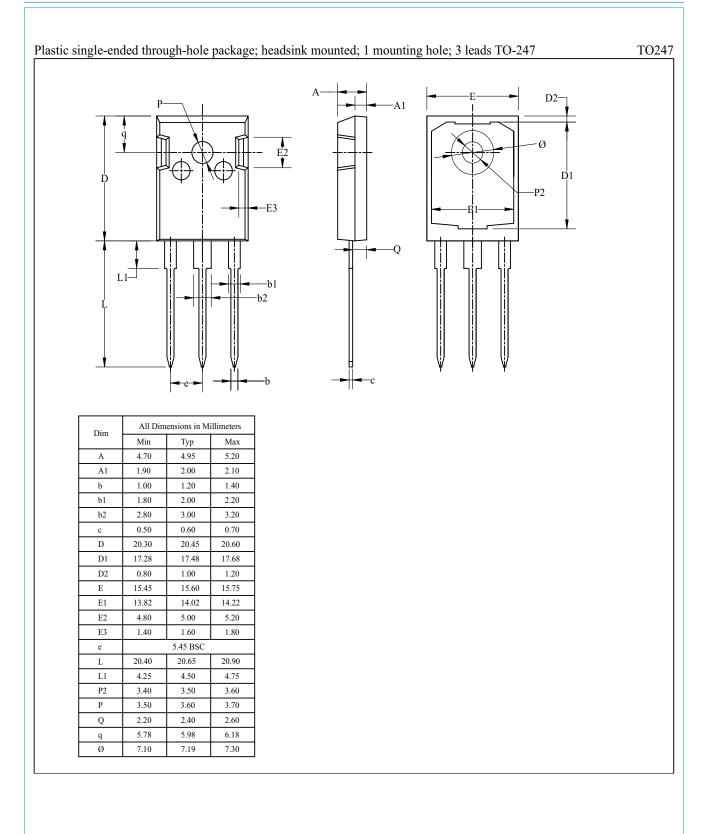
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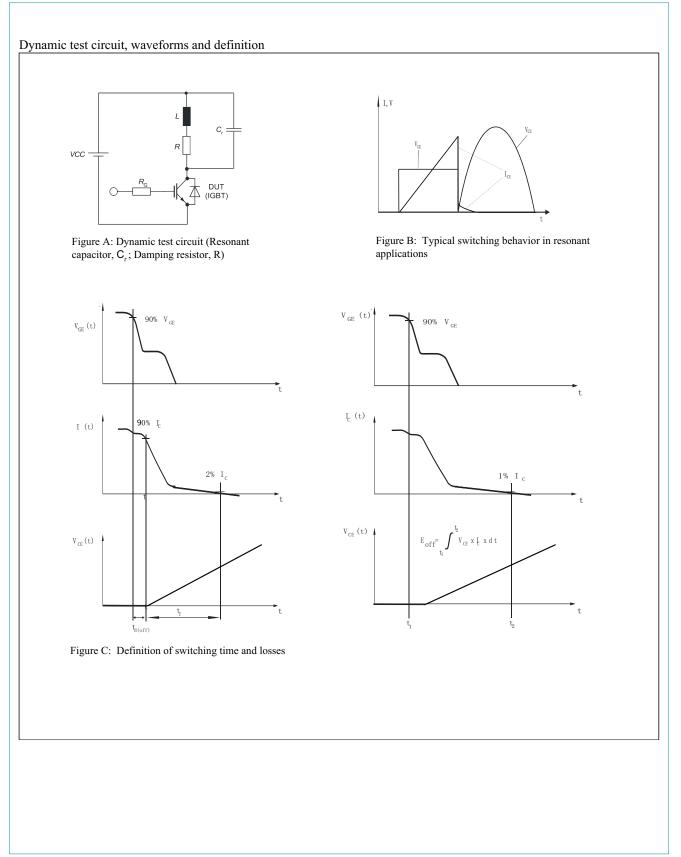


WG30R135W1 **IGBT**

12. Package outline



13. Dynamic test circuit, waveforms and definition



14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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